

# Henry Geerlings | Resume

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*A motivated engineering student with an emphasis in material mechanics and computational modeling. Experience in molecular dynamics, finite element method, and numerical analysis.*

## Education

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### University of California

B.S. Materials Science & Engineering, GPA - 3.2

**Berkeley**

2011 - Dec. 2015

## Experience

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### Lawrence Berkeley National Laboratory

Affiliate

**Berkeley**

Aug. 2015 - Current

Participating in a collaboration between the Materials Project and UC Berkeley for implementing defect-dislocation interaction energies into the Materials Project database.

*Detailed achievements:*

- Using existing elastic constants data from the database to feed into continuum model for interactions.
- Generating (interstitial) defect structures of varying supercell size and chemical species for DFT calculations using the "Python Materials Genomics" package.

### Lawrence Berkeley National Laboratory

Intern

**Berkeley**

June 2015 - Aug. 2015

Coded and analyzed multiple searching algorithms for large scale materials optimization. Coupled with the Materials Project, this would allow on-the-fly materials screening using the Materials API for the computationally budget conscious.

*Detailed achievements:*

- Search methodologies included genetic algorithms and as well as more black box global optimization engines.
- Applications included water splitting materials (band gap/edge) and ductile intermetallics (bulk/shear modulus).

### Chrzan Computational Materials Group

Undergraduate Researcher

**Berkeley**

Jan. 2014 - Jan. 2015

Performed molecular dynamics simulations of dislocations near the phase transformation temperature of pure titanium in order to characterize cold working effects.

*Detailed achievements:*

- Verified thermal expansion behavior of empirical potential model by comparing to experimental results.
- Visually mapped out multiple phases near the transition temperature using bond order parameters.

## Computing

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**OS:** Windows, OS X, Ubuntu (Linux)

**Technical:** FEnICS, Comsol, LAMMPS, VMD, ParaView

**Utility:** Git, Virtualenv, LaTeX, MS Office

**Languages:** Python, Bash, Matlab

## Publications

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De Jong, M., Chen, W., Geerlings, H., Asta, M., and Persson, K. (2015). A database to enable discovery and design of piezoelectric materials. *Scientific Data* **2**, 1500053

## Coursework

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### Materials Science and Engineering:

- Crystallography, Bonding, and Defects
- Phase Transformations and Kinetics
- Properties of Electronic Materials
- Mechanical Behavior of Materials
- Experimental Materials Science
- Materials Characterization
- Materials Production
- Polymeric Materials
- Corrosion

### Mechanical Engineering:

- Simulation of Advanced Manufacturing Processes
- Engineering Analysis using FEM
- Continuum Mechanics
- Engineering Dynamics
- Solid Mechanics
- Heat Transfer

### Engineering:

- Computer Programming with MATLAB
- Methods of Engineering Analysis
- Engineering Thermodynamics

## Extracurricular

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**Societies:** ACerS, AIST, ASM, TMS

**Hobby:** Woodturning, backgammon